



US00D887395S

(12) **United States Design Patent**
Wang

(10) **Patent No.:** **US D887,395 S**
(45) **Date of Patent:** **** Jun. 16, 2020**

- (54) **WIRELESS HEADSET**
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- (73) Assignee: **Shenzhen Earfun Technology Co., Ltd.**, Shenzhen (CN)

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(Continued)

(**) Term: **15 Years**

(21) Appl. No.: **29/681,080**

(22) Filed: **Feb. 22, 2019**

(30) **Foreign Application Priority Data**

Jan. 10, 2019 (CN) 2019 3 0012281

(51) **LOC (12) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/223, 205; D24/174; D13/107, 108;
455/90.3, 575.1, 569.1
CPC H04R 1/10; H04R 25/00; H04R 1/1016;
H04R 1/1066; H04R 5/033; H04R
5/0335; H04R 1/1091; H04R 1/1083;
A61F 11/08
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a wireless headset, as shown and described.

DESCRIPTION

FIG. 1 is a first perspective view of a wireless headset showing my design;

FIG. 2 is a second perspective view of the wireless headset of FIG. 1;

FIG. 3 is a front elevational view of the wireless headset of FIG. 1;

FIG. 4 is a rear elevational view of the wireless headset of FIG. 1;

FIG. 5 is a left side elevational view of the wireless headset of FIG. 1;

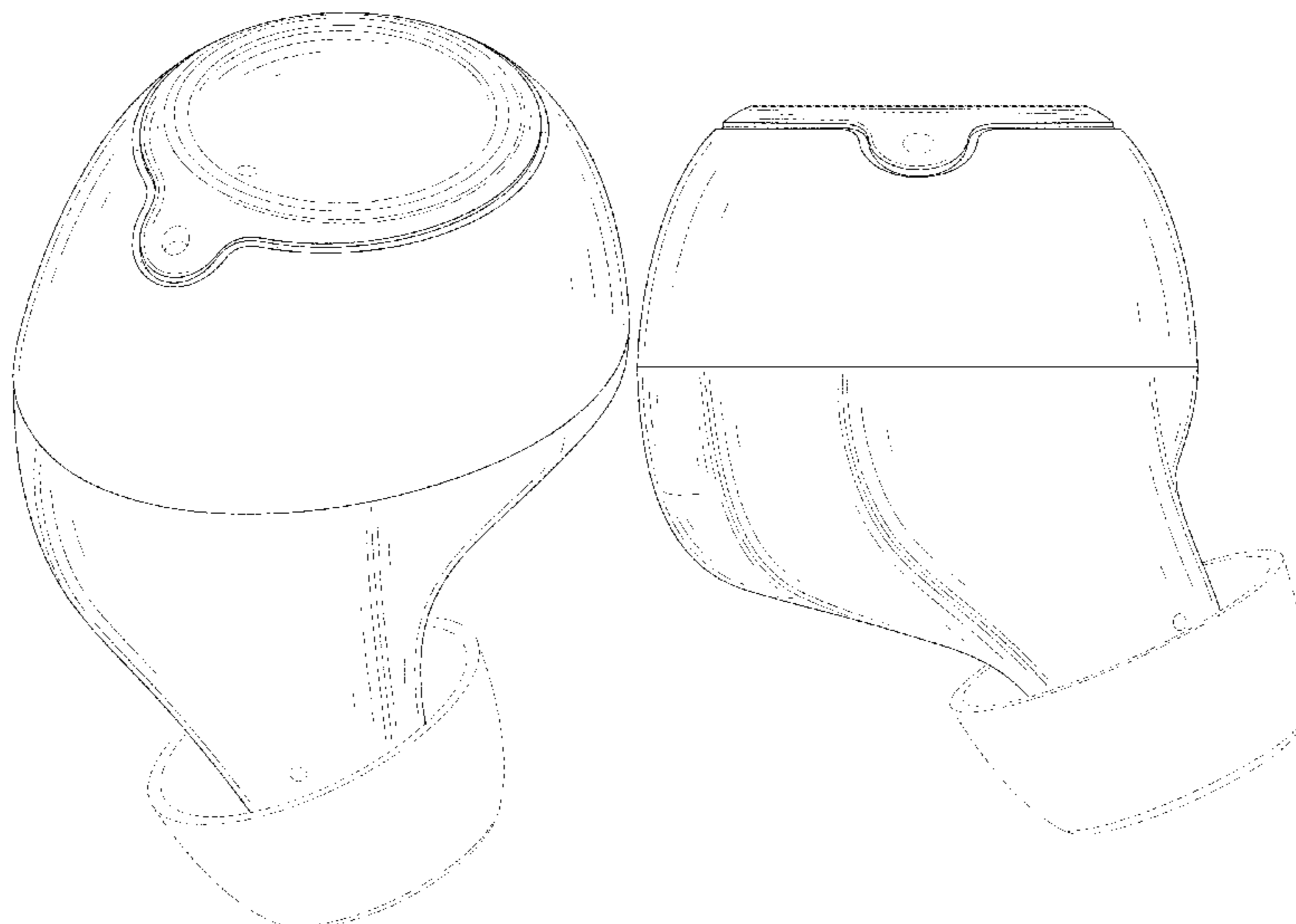
FIG. 6 is a right side elevational view of the wireless headset of FIG. 1;

FIG. 7 is a top plan view of the wireless headset of FIG. 1; and,

FIG. 8 is a bottom plan view of the wireless headset of FIG. 1.

The broken lines and unshaded regions bounded by broken lines form no part of the claimed design.

1 Claim, 8 Drawing Sheets



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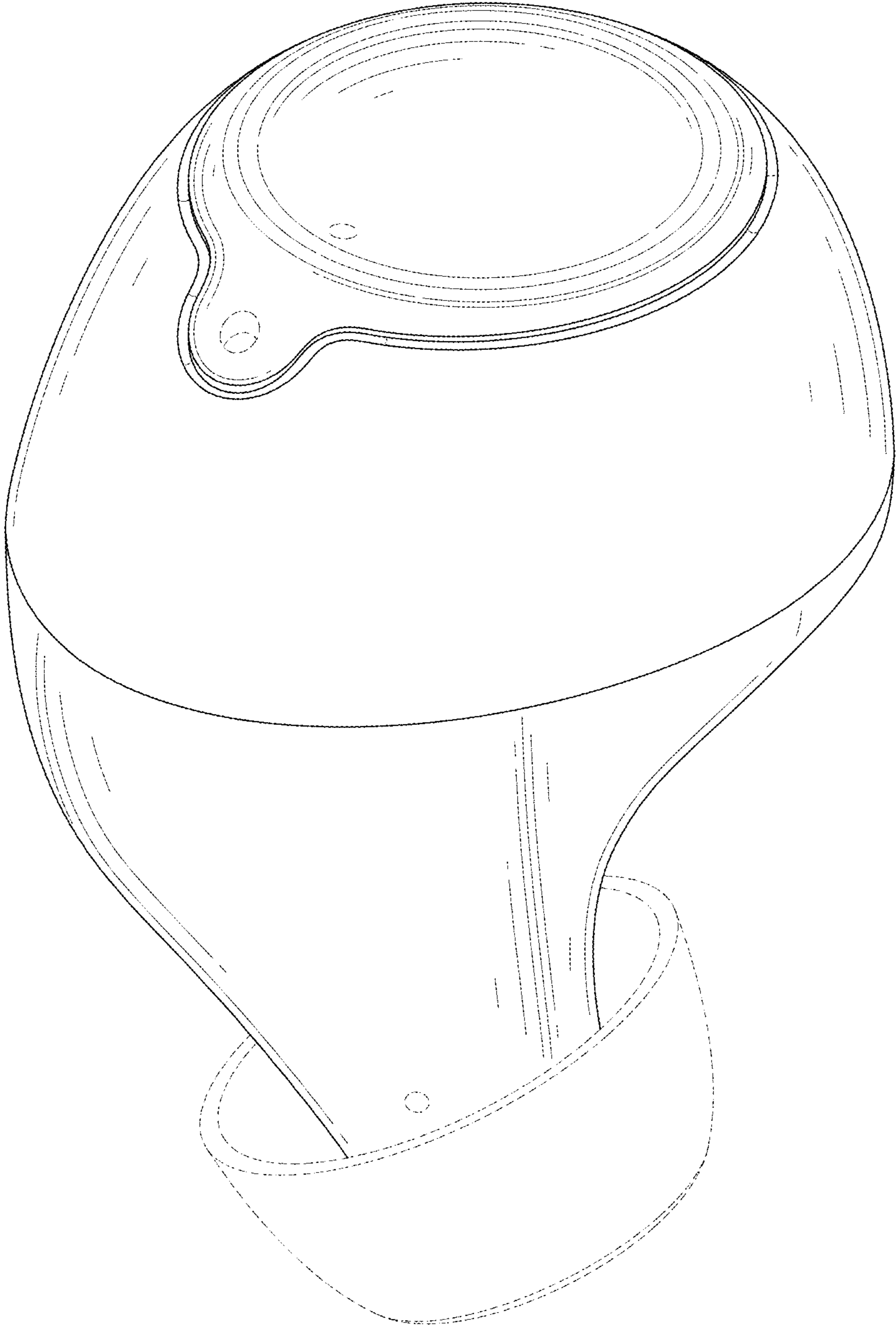


FIG. 1

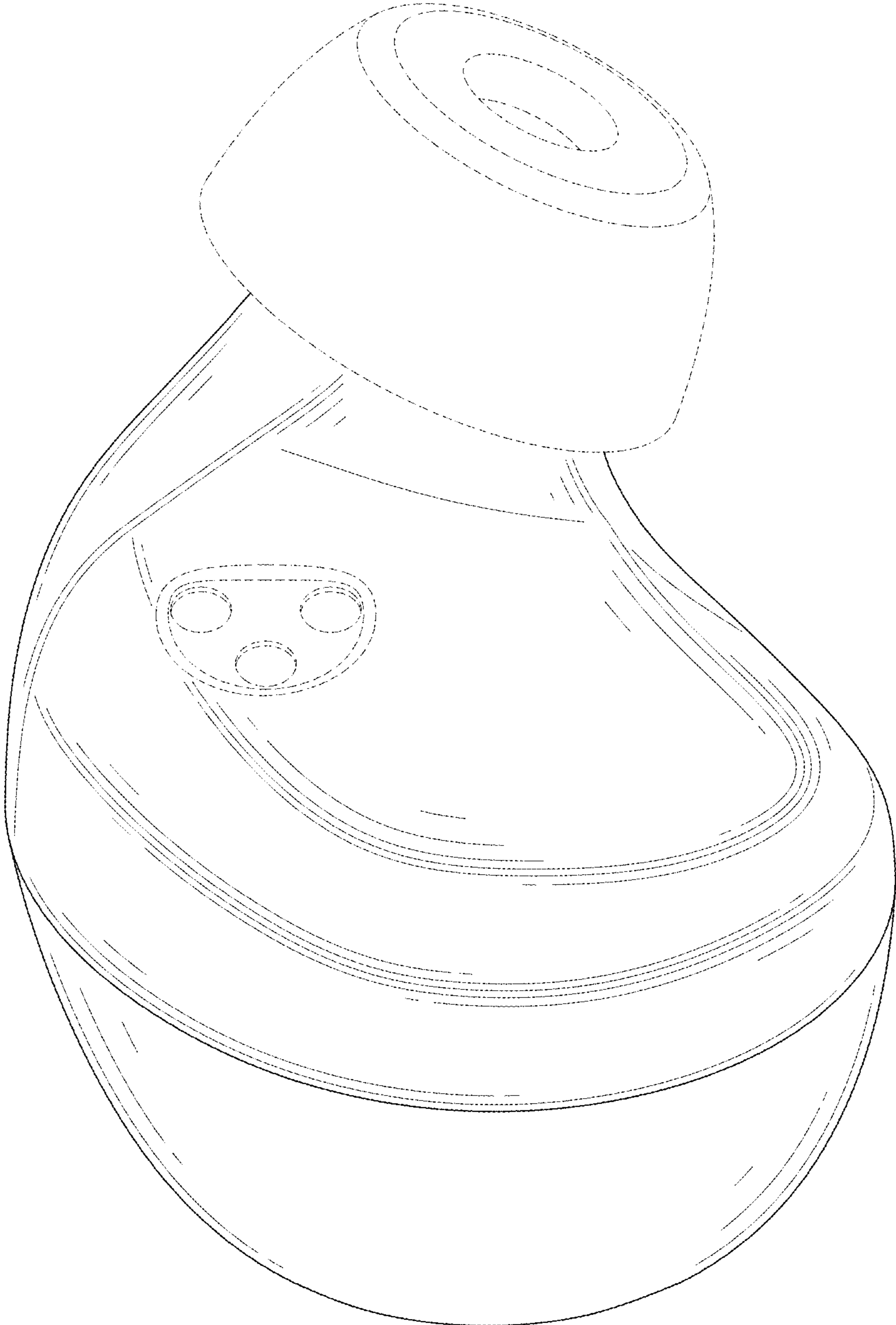


FIG. 2

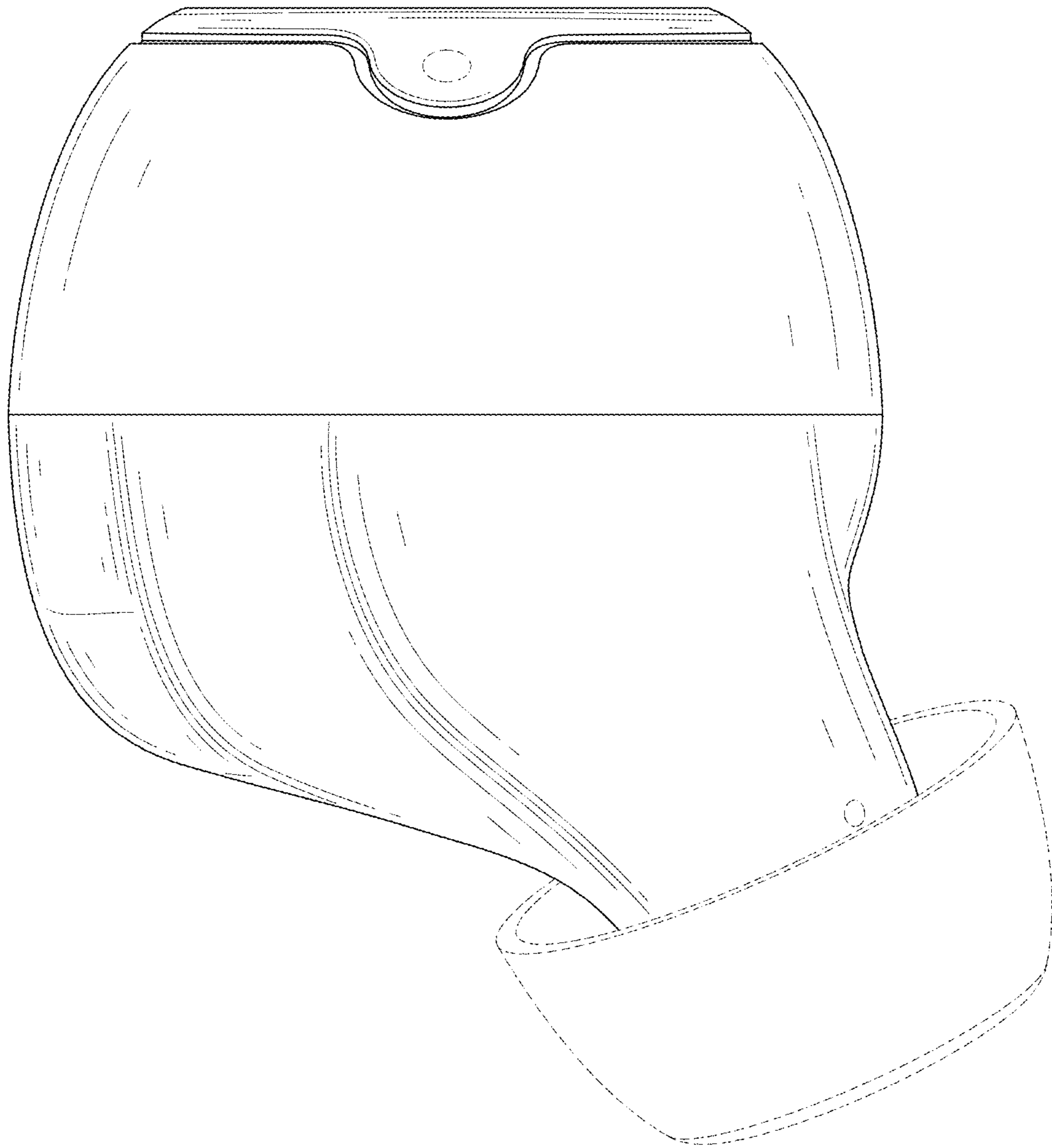


FIG. 3

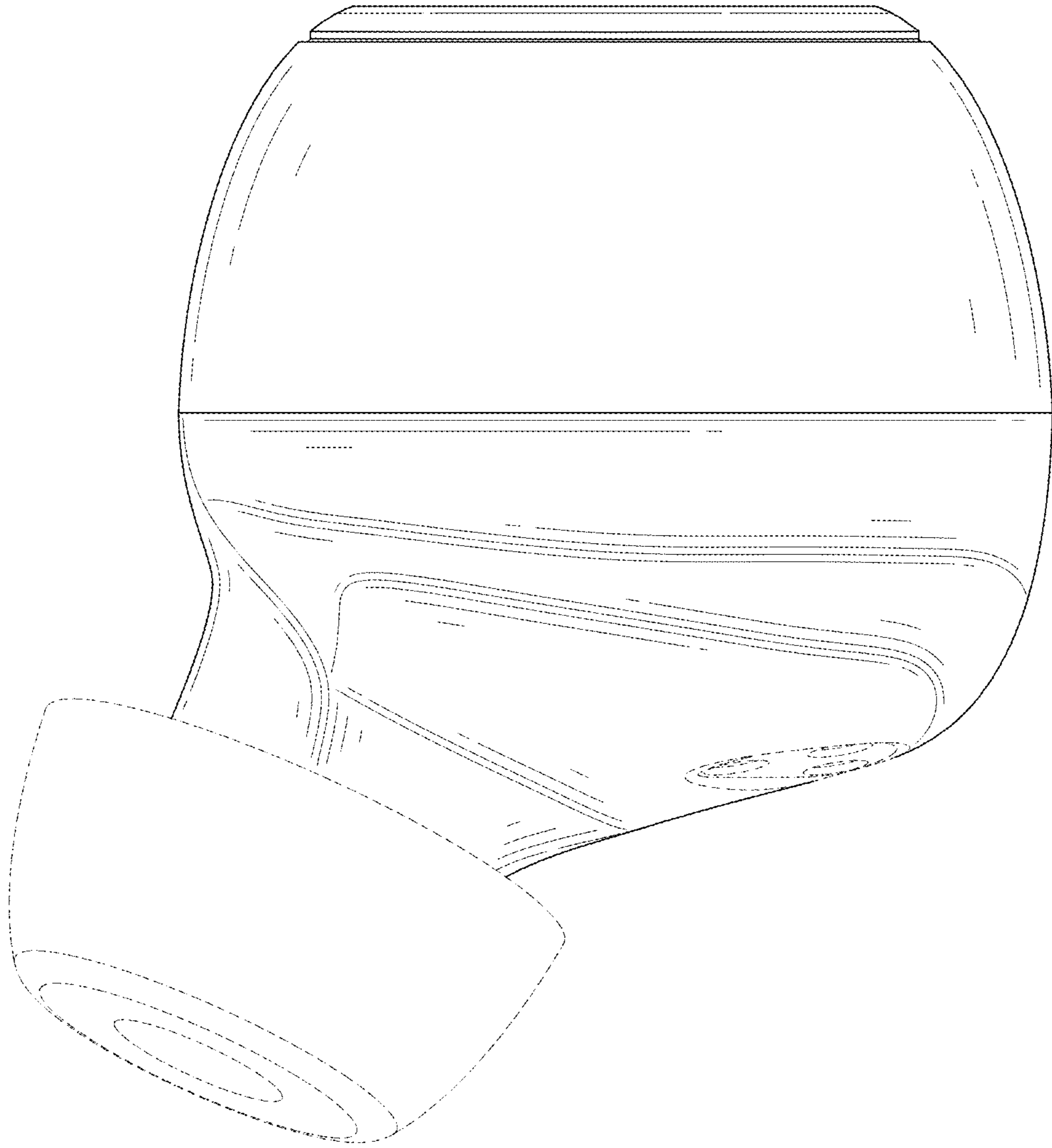


FIG. 4

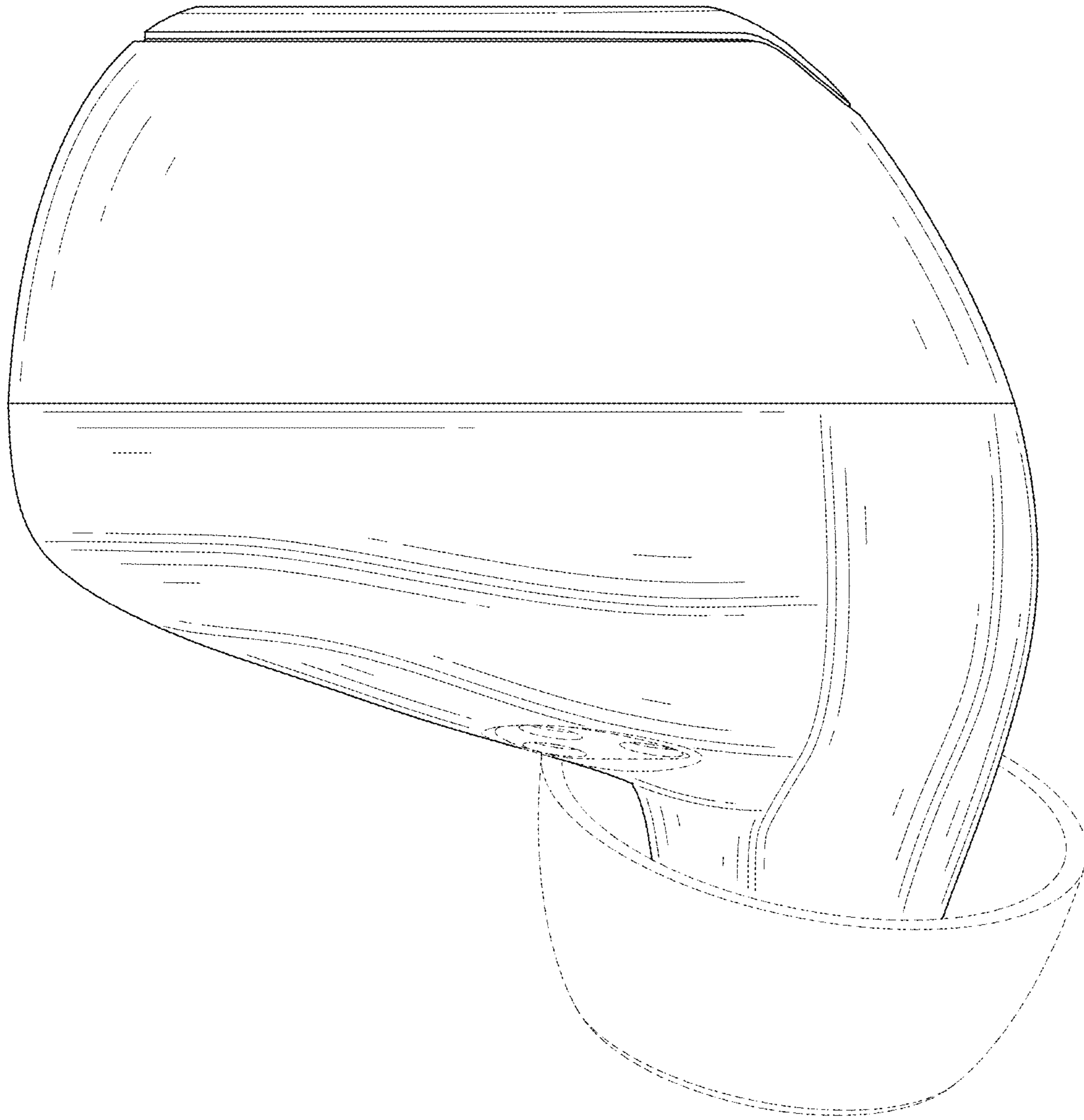


FIG. 5

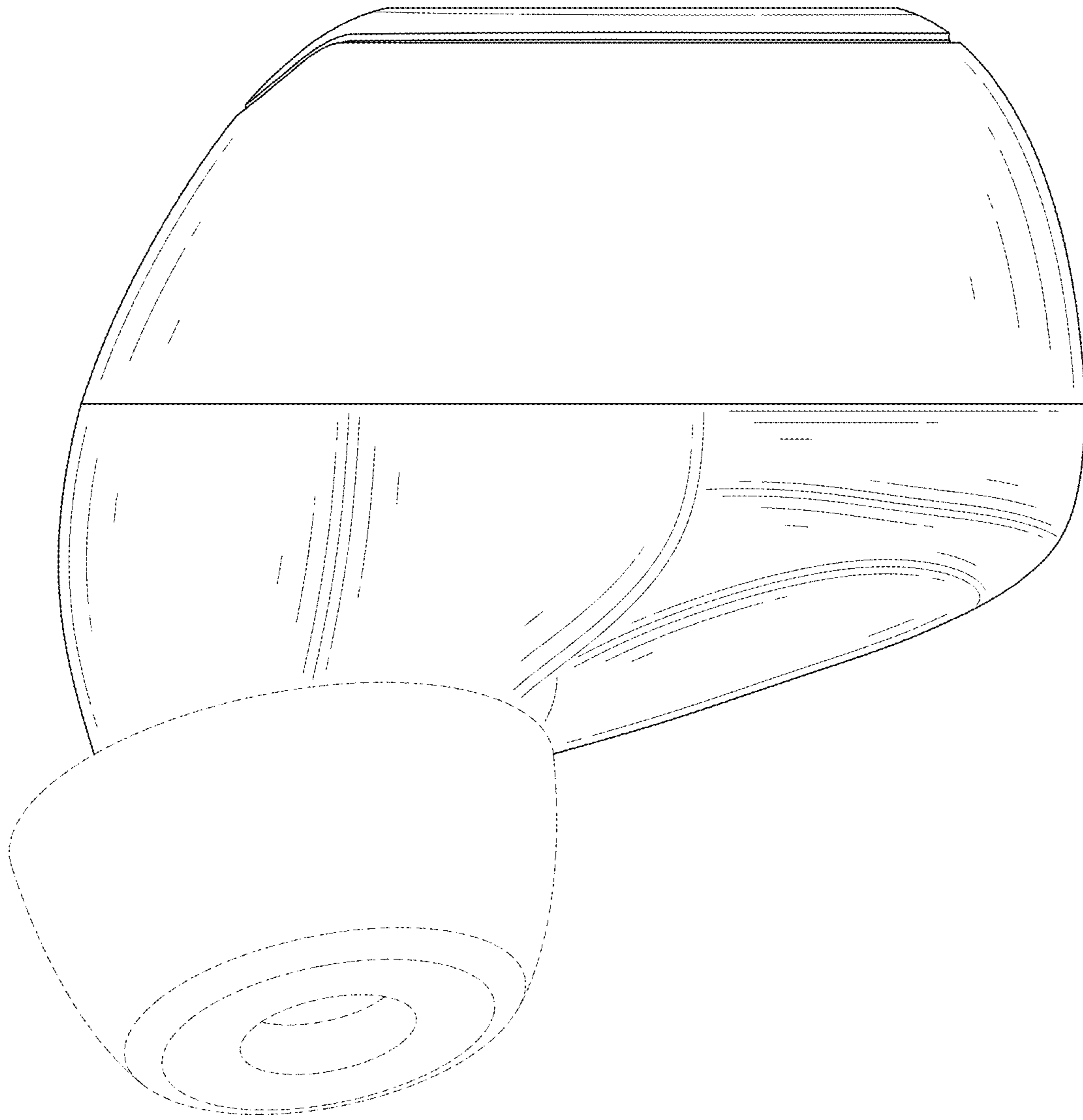


FIG. 6

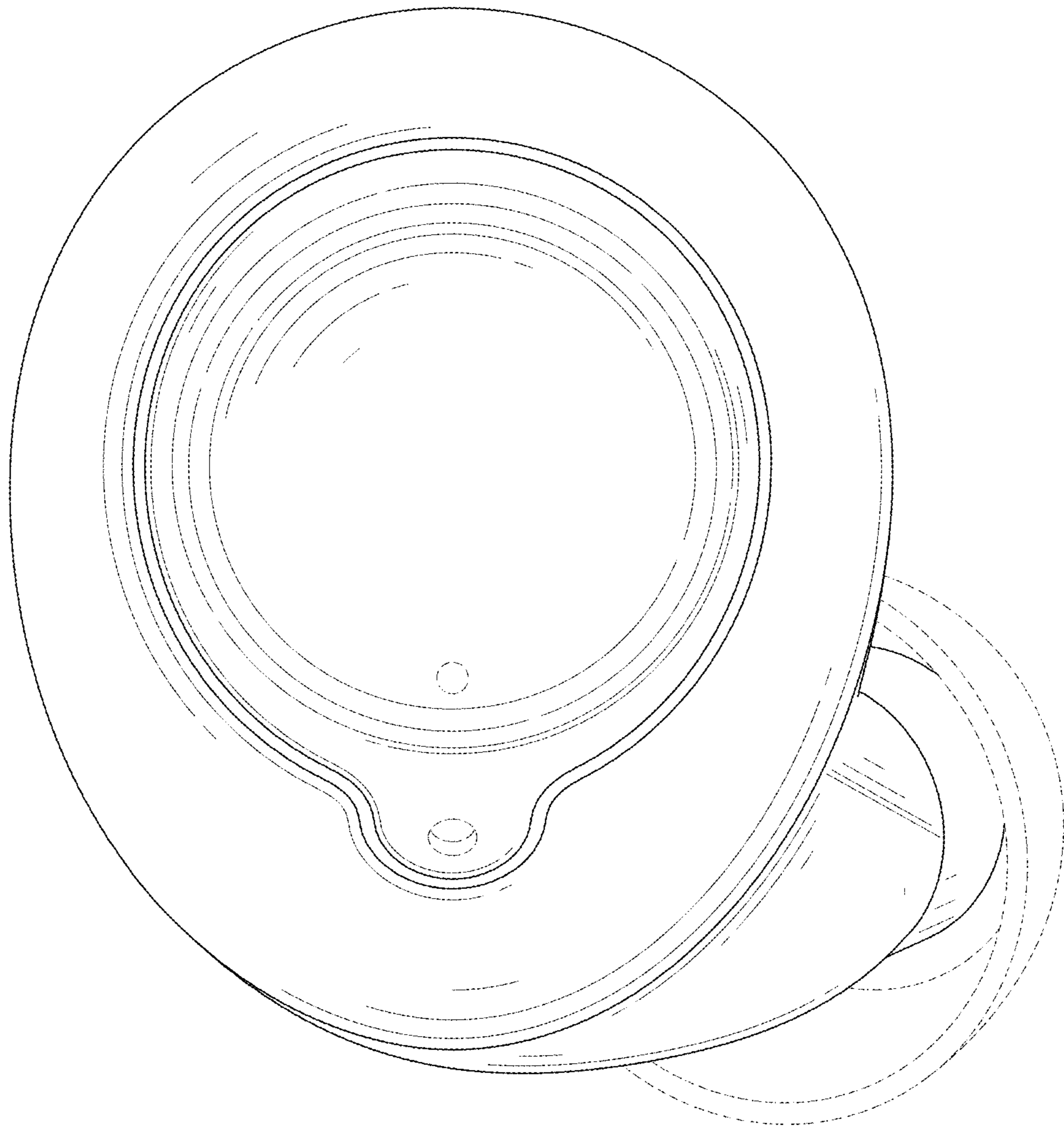


FIG. 7

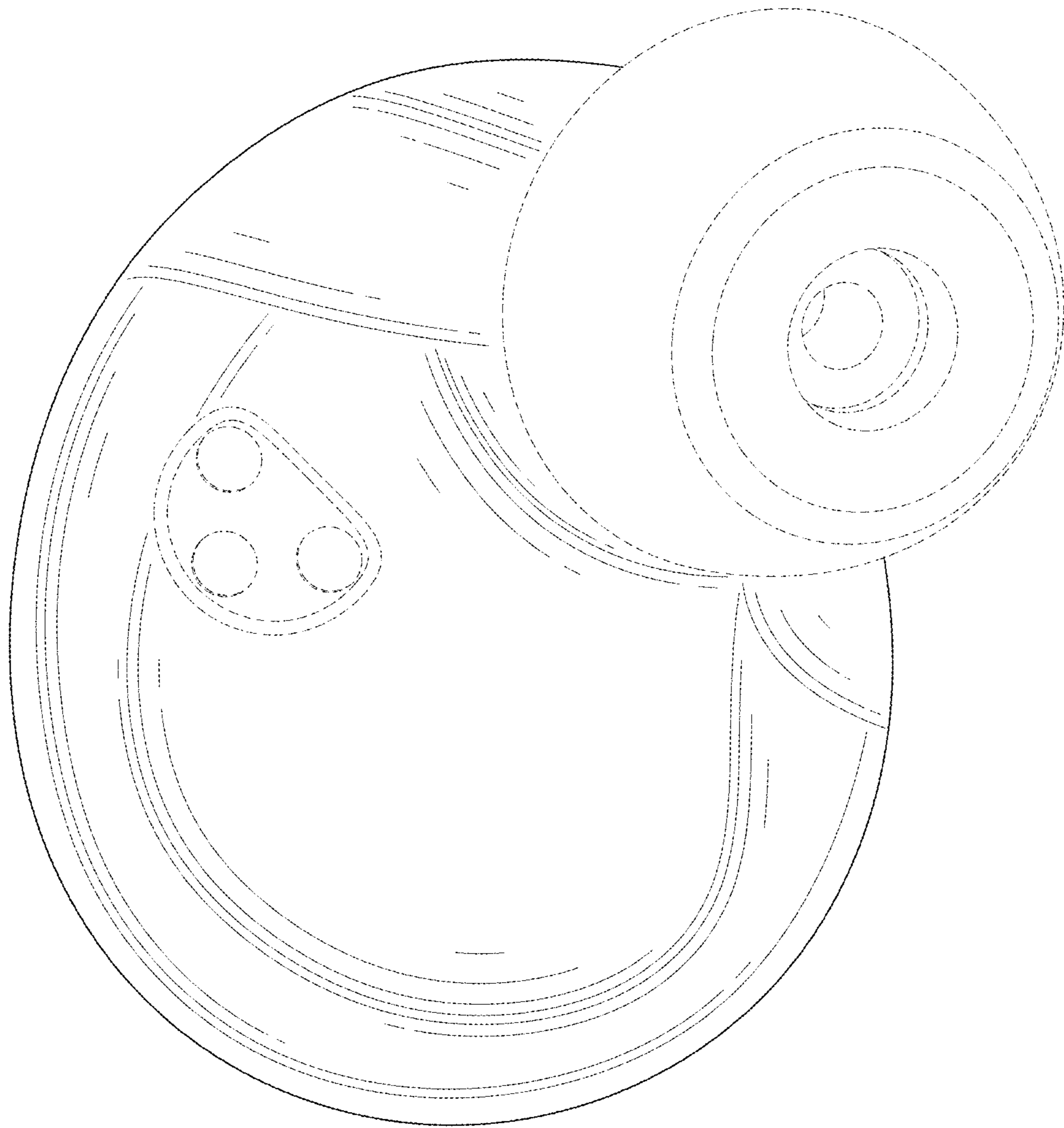


FIG. 8